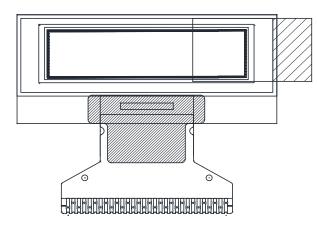


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RoHS

COMPLIANT

128 x 32 Graphic OLED



MECHANICAL DATA				
ITEM	UNIT			
Module dimension	33.4 x 14.5 x 1.65			
Viewing area	27.68 x 7.80			
Active area	25.58 x 6.38	mm		
Dot size	0.176 x 0.176	mm		
Dot pitch	0.200 x 0.200			
Mounting hole	n/a			

FEATURES

- Type: graphic
- Display format: 128 x 32 dots
- Built-in controller: SSD1306BZ
- Duty cycle: 1/32
- +3 V power supply
- Interface: I²C, 4-wire SPI, 6800, 8080
- Without polarizer
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

ABSOLUTE MAXIMUM RATINGS							
ITEM	SYMBOL	STANDAF	UNIT				
	STMBOL	MIN.	MAX.	UNIT			
Supply voltage for logic ⁽¹⁾⁽²⁾	V_{DD}	0	4	V			
Supply voltage for display ⁽¹⁾⁽²⁾	V_{CC}	0	16	V			
Operating temperature	T _{OP}	-40	+80	ာ့			
Storage temperature	T _{STG}	-40	+80				

Notes

- ⁽¹⁾ All the above voltages are on the basis of " $V_{SS} = 0 V$ "
- ⁽²⁾ When this module is used beyond the above absolute maximum ratings, permanent breakage of the module may occur. Also, for normal operations, it is desirable to use this module under the conditions according to "Electrical Characteristics". If this module is used beyond these conditions, malfunctioning of the module can occur and the reliability of the module may deteriorate

ELECTRICAL CHARACTERISTICS						
ITEM	SYMBOL CONDITION	ST	STANDARD VALUE			
		MIN.	TYP.	MAX.	UNIT	
Supply voltage for logic	V _{DD}	-	2.8	3.0	3.3	
Supply voltage for display	V _{CC}	-	7.0	7.25	7.5	
High level input	V _{IH}	-	0.8 V _{DD}	-	V _{DDI/O}	v
Low level input	VIL	-	0	-	0.2 V _{DD}	v
High level output	V _{OH}	-	0.9 V _{DD}	-	V _{DDI/O}	
Low level output	V _{OL}	-	0	-	0.1 V _{DD}	
50 % check board operating current	I _{DD}	$V_{CC} = 7.25 V$	4	5	6	mA

OPTIONS				
		EMITTING COLOR		
YELLOW	GREEN	RED	BLUE	WHITE
Yes	-	-	-	-

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INTERFA	CE PIN FUN	NCTION						
PIN NO.	SYMBOL		FUNCTION	1				
1	NC (GND)	Reserved pin (supporting pin) The supporting pins can reduce connected to external ground	The supporting pins can reduce the influences from stresses on the function pins. These pins must be					
2	C2N							
3	C2P	Positive terminal of the flying inve				onverter		
4	C1P	is not used	The charge-pump capacitors are required between the terminals. They must be floated when the converter is not used					
5	C1N							
6	V _{BAT}	Power supply for DC/DC converter This is the power supply pin for th external source when the converter	e internal buffer of the DO					
7	NC	No connection						
8	V _{SS}	Ground of logic circuit This is a ground pin. It acts as a re	eference for the logic pin	s. It must be connec	ted to external grou	und		
9	V _{DD}	Power supply for logic This is a voltage supply pin. It mu	st be connected to exter	nal source				
10	BS0	Communicating protocol select These pins are MCU interface select	ection input. See the follo	owing table:				
			BS0	BS1	BS2			
		l ² C	0	1	0			
11	BS1	3-wire serial	1	0	0			
		4-wire serial	0	0	0			
		8-bit 68XX parallel	0	0	1			
12	BS2	8-bit 80XX parallel	0	1	1			
13	CS#	Chip select This pin is the chip select input. Th	ne chip is enabled for MC	U communication on	ly when CS# is pull	ed "low"		
14	RES#	Power reset for controller and driv This pin is reset signal input. Whe		tion of the chip is exe	ecuted			
15	D / C#	Data / command control This pin is data / command contro display data. When the pin is pulle For detail relationship to MCU into the pin is pulled "high" and serial is pulled "low", the data at SDIN v SA0 for slave address selection	d "low", the input at D7 to erface signals, please ref interface mode is select	DO will be transferre er to the timing char ed, the data at SDIN	ed to the command acteristics diagram is treated as data.	register. s. When When it		
16	R / W#	read / write (R / W#) selection inpu When 80XX interface mode is sele						
17	E /RD#	the enable (E) signal. Read / write "low". When connecting to an 80						
18 to 25	D0 to D7	mode is selected, D1 will be the s	Host data input / output bus These pins are 8-bit bi-directional data bus to be connected to the microprocessor's data bus. When serial mode is selected, D1 will be the serial data input SDIN and D0 will be the serial clock input SCLK. When I ² C mode is selected, D2 and D1 should be tired together and serve as SDA _{out} and SDA _{in} in application and					
26	I _{REF}	Current reference for brightness a This pin is segment current referer current lower than 12.5 µA		be connected betwe	een this pin and V_{SS}	. Set the		

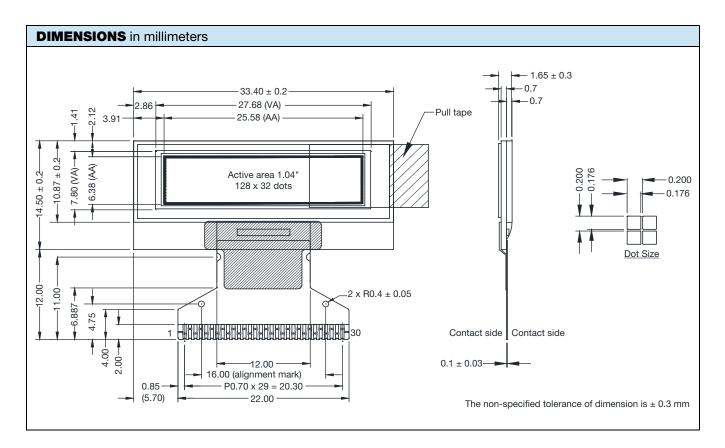
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INTERFA	INTERFACE PIN FUNCTION				
PIN NO.	SYMBOL	FUNCTION			
27	V _{COMH}	Voltage output high level for COM signal This pin is the input pin for the voltage output high level for COM signals. A capacitor should be connected between this pin and V_{SS}			
28	V _{CC}	Power supply for OEL panel This is the most positive voltage supply pin of the chip. A stabilization capacitor should be connected between this pin and V _{SS} when the converter is used. It must be connected to external source when the converter is not used			
29	V _{LSS}	Ground of analog circuit This is an analog ground pin. It should be connected to $V_{\rm SS}$ externally			
30	NC (GND)	Reserved pin (supporting pin) The supporting pins can reduce the influences from stresses on the function pins. These pins must be connected to external ground			



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MODULE CLA	SSIFICATION INFORM	ATION						
OLED -	128 O 032 E	- L N P 3 N 0 0 000						
1	Brand	Vishay Intertechnology, Inc.						
2	Horizontal format	128 columns						
		F: COG type, with frame						
		H: graphic type						
3	Display type	N: character type						
		O: COG type						
		Y: tab type						
4	Vertical format	32 lines						
5	Serials code	E						
		A: amber						
		B: blue						
		C: full color						
		G: green						
6	Emitting color	L: yellow						
		R: red						
		S: sky blue						
		W: white						
		X: yellow / sky blue (dual color)						
		Y: yellow green						
7	Polarizer	N: without polarizer						
		P: with polarizer						
8	Display mode	A: active matrix						
		P: passive matrix						
9	Driver voltage	3: 3.0 V to 3.3 V						
	, , , , , , , , , , , , , , , , , , ,	5: 5.0 V						
10	Touch panel	N: without touch panel						
		T: with touch panel						
		0: standard						
4.4	Due duete true e	1: sunlight readable						
11	Products type	2: transparent OLED (TOLED)						
		3: flexible OLED						
		4: OLED for lighting						
		0: standard (A level) 2: B level						
10	Product grades	2: Bilevel 3: C level						
12	Froduct grades	4: high class (AA level)						
		4: nigh class (AA level) 5: customer offerings						
13	Serial number							
13		Application serial number (000 to ZZZ)						

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GENERAL SPECIFICATIONS					
ITEM	DIMENSION	UNIT			
Dot matrix	128 x 64				
Module dimension	33.4 x 14.5 x 1.65	mm			
Viewing area	27.68 x 7.80	mm			
Active area	25.58 x 6.38	mm			
Dot size	0.176 x 0.176	mm			
Dot pitch	0.200 x 0.200	mm			
Display mode	Passive matrix				
Display color	Yellow				
Drive duty	1/32 duty				
IC	SSD1306BZ				

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FUNCTION BLOCK DIAGRAM

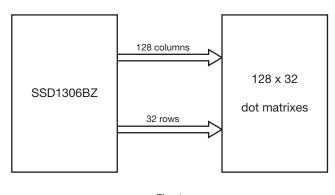
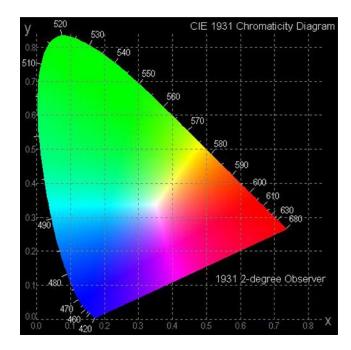


Fig. 1

 For more information, please refer to Application Note provided by Vishay

OPTICAL CHARACTERISTICS							
ITEM	SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT	
View angle	(V)0		160	-	-	dog	
view angle	(H)φ		160	-	-	deg	
Contrast ratio	CR	Dark	2000 : 1	-	-	-	
Boononoo timo	t _{rise}		-	10	-	μs	
Response time	t _{fall}		-	10	-	μs	
Display with 50 % check board brightness			100	120	-	cd/m ²	
CIE _x (yellow)	(CIE1931)		0.45	0.47	0.49		
CIE _y (yellow)	(CIE1931)		0.48	0.50	0.52		

Note



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OLED LIFETIME

CONDITIONS	MIN.	TYP.
$T_A = 25$ °C, initial 50 % check board brightness typical value	50 000 h	-
-		

Notes

• Life time is defined the amount of time when the luminance has decayed to < 50 % of the initial value

• This analysis method uses life data obtained under accelerated conditions to extrapolate an estimated probability density function (PDF) for the product under normal use conditions

Screen saving mode will extend OLED lifetime

RELABILITY		
ENVIRONMENTAL TEST		
TEST ITEM	CONTENT OF TEST	TEST CONDITION
High temperature storage	Endurance test applying the high storage temperature for a long time	80 °C, 240 h
Low temperature storage	Endurance test applying the low storage temperature for a long time	-40 °C, 240 h
High temperature operation	Endurance test applying the electric stress (voltage and current) and the thermal stress to the element for a long time	80 °C, 240 h
Low temperature operation	Endurance test applying the electric stress under low temperature for a long time	-40 °C, 240 h
High temperature / humidity storage	Endurance test applying the high temperature and high humidity storage for a long time	60 °C, 90 % RH, 240 h
Temperature cycle	Endurance test applying the low and high temperature cycle -40 °C 25 °C 80 °C	-40 °C / 80 °C, 100 cycles
	1 cycle	
MECHANICAL TEST		
Vibration test	Endurance test applying the vibration during transportation and using	10 Hz to 22 Hz for 1.5 mm peak-to-peak 22 Hz to 500 Hz for 1.5 <i>g</i> , total 0.5 h
Shock test	Constructional and mechanical endurance test applying the shock during transportation	50 <i>g</i> half sin wave 11 ms, 3 times of each direction
Atmospheric pressure test	Endurance test applying the atmospheric pressure during transportation by air	115 mbar, 40 h
OTHERS		
Static electricity test	Endurance test applying the electric stress to the terminal	V_{S} = \pm 600 V (contact), \pm 800 V (air), R_{S} = 330 $\Omega,$ C_{S} = 150 pF, 10 times

Note

Supply voltage for OLED system = operating voltage at 25 °C

TEST AND MEASUREMENT CONDITIONS

- 1. All measurements shall not be started until the specimens attain to temperature stability. After the completion of the described reliability test, the samples were left at room temperature for 2 hours prior to conducting the failure test at 23 °C ± 5 °C, 55 % ± 15 % RH
- 2. All-pixels-on is used as operation test pattern
- 3. The degradation of polarizer are ignored for high temperature storage, high temperature / humidity storage, temperature cycle

EVALUATION CRITERIA

- 4. The function test is OK
- 5. No observable defects
- 6. Luminance: > 50 % of initial value
- 7. Current consumption: within ± 50 % of initial value

APPENDIX: RESIDUE IMAGE

Because the pixels are lighted in different time, the luminance of active pixels may reduce or differ from inactive pixels. Therefore, the residue image will occur. To avoid the residue image, every pixel needs to be lighted up uniformly.

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INSF	PECTION SPECI	FICATION						
NO.	ITEM		CRITERIC	DN .		AQL		
01	Electrical testing	 1.1 Missing vertical, horizontal segment, segment contrast defect 1.2 Missing character, dot or icon 1.3 Display malfunction 1.4 No function or no display 1.5 Current consumption exceeds product specifications 1.6 OLED viewing angle defect 1.7 Missing and the second s						
	Black or white	 1.7 Mixed product types 1.8 Contrast defect 	1.7 Mixed product types					
02	spots on OLED (display only)	2.2 Densely spaced: no mor	2.2 Densely spaced: no more than two spots or lines within 3 mm					
		3.1 Round type: as following $\Phi = (x + y) / 2$	g drawing	SIZE	ACCEPTABLE QTY			
	OLED black spots, white spots,				Accept no dense 2 1	2.5		
03				0.25 < Φ	0			
00	contamination (non-display)	3.2 Line type	LENGTH	WIDTH	ACCEPTABLE QTY			
	(Interesting)	(as following drawing)	- L≤3.0 L≤2.5	$\label{eq:W} \begin{split} &W \leq 0.02 \\ &0.02 < W \leq 0.03 \\ &0.03 < W \leq 0.05 \end{split}$	Accept no dense 2	2.5		
		→ L ←	-	0.05 < W	As round type			
04	Polarizer bubbles	If bubbles are visible, judge specifications, not easy to fi specify direction.		SIZE Φ $\Phi \le 0.20$ $0.20 < \Phi \le 0.50$ $0.50 < \Phi \le 1.00$ $1.00 < \Phi$ Total QTY	ACCEPTABLE QTY Accept no dense 3 2 0 3	2.5		
05	Scratches	Follow no. 3 OLED black spots	, white spots, contami	ination				
		Symbols: x: chip length k: seal width l: electrode pad length 6.1 General glass chip: 6.1.1 Chip on panel surface ar	y: chip width t: glass thickness nd crack between pan	els:	z: chip thickness a: OLED side length			
06	Chipped glass			× v v		2.5		
		z: chip thickness	y: chip width		x: chip length			
		$z \le 1/2 t$ 1/2 t < z $\le 2 t$	Not over viewing a Not exceed 1/3 k	area	x ≤ 1/8 a x ≤ 1/8 a			
		Note • If there are 2 or more chips,		ch chip	x ≥ 1/0 d			

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INS	PECTION SPEC				
NO.	ITEM		CRITERION		AQL
06	Chipped glass	6.1.2 Corner crack: z: chip thickness $z \le 1/2 t$ $1/2 t < z \le 2 t$ Note	y: chip width Not over viewing area Not exceed 1/3 k	x: chip length x ≤ 1/8 a x ≤ 1/8 a	2.5
		Symbols: x: chip length k: seal width l: electrode pad length 6.2 Protrusion over term 6.2.1 Chip on electrode p y: chip width y ≤ 0.5 mm	ad: x: chip length $x \le 1/8$ a	z: chip thickness a: OLED side length z: chip thickness $0 < z \le t$	
06	Glass crack	according to electrode te	x: chip length x $\leq 1/8$ a		2.5
07	Cracked glass	The OLED with extensive of	rack is not acceptable		2.5

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INSPECTION SPECIFICATION						
NO.	ITEM	CRITERION	AQL			
08	Backlight elements	8.1 Illumination source flickers when lit	0.65			
		8.2 Spots or scratched that appear when lit must be judged. Using OLED spot, lines and contamination standards	2.5			
		8.3 Backlight does not light or color wrong	0.65			
09	Bezel	9.1 Bezel may not have rust, be deformed or have fingerprints, stains or other contamination	2.5			
		9.2 Bezel must comply with job specifications	0.65			
	PCB, COB	10.1 COB seal may not have pinholes larger than 0.2 mm or contamination	2.5			
		10.2 COB seal surface may not have pinholes through to the IC	2.5			
		10.3 The height of the COB should not exceed the height indicated in the assembly diagram	0.65			
		10.4 There may not be more than 2 mm of sealant outside the seal area on the PCB. And there should be no more than three places	2.5			
10		10.5 No oxidation or contamination PCB terminals	2.5			
		10.6 Parts on PCB must be the same as on the production characteristic chart. There should be no wrong parts, missing parts or excess parts	0.65			
		10.7 The jumper on the PCB should conform to the product characteristic chart	0.65			
		10.8 If solder gets on bezel tab pads, OLED pad, zebra pad or screw hold pad, make sure it is smoothed down	2.5			
	Soldering	11.1 No un-melted solder paste may be present on the PCB	2.5			
		11.2 No cold solder joints, missing solder connections, oxidation or icicle	2.5			
11		11.3 No residue or solder balls on PCB	2.5			
		11.4 No short circuits in components on PCB	0.65			
	General appearance	12.1 No oxidation, contamination, curves or, bends on interface pin (OLB) of TCP	2.5			
		12.2 No cracks on interface pin (OLB) of TCP	0.65			
12		12.3 No contamination, solder residue or solder balls on product	2.5			
		12.4 The IC on the TCP may not be damaged, circuits	2.5			
		12.5 The uppermost edge of the protective strip on the interface pin must be present or look as if it cause the interface pin to sever	2.5			
		12.6 The residual rosin or tin oil of soldering (component or chip component) is not burned into brown or black color	2.5			
		12.7 Sealant on top of the ITO circuit has not hardened	2.5			
		12.8 Pin type must match type in specification sheet	0.65			
		12.9 OLED pin loose or missing pins	0.65			
		12.10 Product packaging must the same as specified on packaging specification sheet	0.65			
		12.11 Product dimension and structure must conform to product specification sheet	0.65			



OLED-1280032E-LNP3N00000

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CHECK ITEM	CLASSIFICATION	CRITERIA
No display	Major	
Missing line	Major	
Missing line		
Pixel short	Major	
Darker short	Major	
Wrong display	Major	
Un-uniform	Major	
B/A x 100 % < 70 % A/C x 100 % < 70 %		A Normal B Dark pixel C Light pixel

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PRECAUTIONS IN USE OF OLED MODULES

MODULES

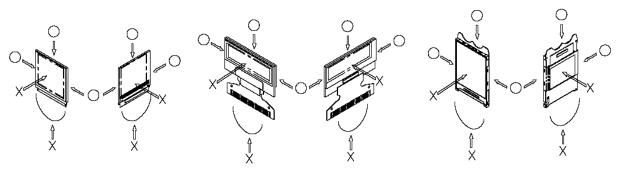
- 1. Avoid applying excessive shocks to module or making any alterations or modifications to it
- 2. Do not make extra holes on the printed circuit board, modify its shape or change the components of OLED display module
- 3. Do not disassemble the OLED display module
- 4. Do not operate it above the absolute maximum rating
- 5. Do not drop, bend or twist OLED display module
- 6. Soldering: only to the I/O terminals
- 7. Storage: please storage in anti-static electricity container and clean environment
- 8. It is pretty common to use "screen saver" to extend the lifetime and do not use fix information for long time in real application
- 9. Do not use fixed information in OLED panel for long time, that will extend "screen burn" effect time
- 10. Vishay has the right to change the passive components, including R2 and R3 adjust resistors. (Resistors, capacitors, and other passive components will have different appearance and color caused by the different supplier)
- 11. Vishay have the right to change the PCB Rev. (In order to satisfy the supplying stability, management optimization, and the best product performance... etc, under the premise of not affecting the electrical characteristics and external dimensions, Vishay have the right to modify the version)

HANDLING PRECAUTIONS

- 1. Since the display panel is being made of glass, do not apply mechanical impacts such us dropping from a high position
- 2. If the display panel is broken by some accident and the internal organic substance leaks out, be careful not to inhale nor lick the organic substance
- 3. If pressure is applied to the display surface or its neighborhood of the OLED display module, the cell structure may be damaged and be careful not to apply pressure to these sections
- 4. The polarizer covering the surface of the OLED display module is soft and easily scratched. Please be careful when handling the OLED display module
- 5. When the surface of the polarizer of the OLED display module has soil, clean the surface. It takes advantage of by using following adhesion tape
- Scotch mending tape no. 810 or an equivalent

Never try to breathe upon the soiled surface nor wipe the surface using cloth containing solvent such as ethyl alcohol, since the surface of the polarizer will become cloudy. Also, pay attention that the following liquid and solvent may spoil the polarizer:

- Water
- Ketone
- Aromatic solvents
- 6. Hold OLED display module very carefully when placing OLED display module into the system housing. Do not apply excessive stress or pressure to OLED display module. And, do not over bend the film with electrode pattern layouts. These stresses will influence the display performance. Also, secure sufficient rigidity for the outer cases



- 7. Do not apply stress to the LSI chips and the surrounding molded sections
- 8. Do not disassemble nor modify the OLED display module
- 9. Do not apply input signals while the logic power is off

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- 10. Pay sufficient attention to the working environments when handing OLED display modules to prevent occurrence of element breakage accidents by static electricity
 - Be sure to make human body grounding when handling OLED display modules
 - Be sure to ground tools to use or assembly such as soldering irons
 - To suppress generation of static electricity, avoid carrying out assembly work under dry environments
 - Protective film is being applied to the surface of the display panel of the OLED display module. Be careful since static electricity may be generated when exfoliating the protective film
- 11. Protection film is being applied to the surface of the display panel and removes the protection film before assembling it. At this time, if the OLED display module has been stored for a long period of time, residue adhesive material of the protection film may remain on the surface of the display panel after removed of the film. In such case, remove the residue material by the method introduced in the above no. 5
- 12. If electric current is applied when the OLED display module is being dewed or when it is placed under high humidity environments, the electrodes may be corroded and be careful to avoid the above

STORAGE PRECAUTIONS

- 1. When storing OLED display modules, put them in static electricity preventive bags avoiding exposure to direct sun light nor to lights of fluorescent lamps and, also, avoiding high temperature and high humidity environment or low temperature (less than 0 °C) environments. We recommend you to store these modules in the packaged state when they were shipped from Vishay. At that time, be careful not to let water drops adhere to the packages or bags nor let dewing occur with them
- 2. If electric current is applied when water drops are adhering to the surface of the OLED display module, when the OLED display module is being dewed or when it is placed under high humidity environments, the electrodes may be corroded and be careful about the above

DESIGNING PRECAUTIONS

- 1. The absolute maximum ratings are the ratings which cannot be exceeded for OLED display module, and if these values are exceeded, panel damage may be happen
- To prevent occurrence of malfunctioning by noise, pay attention to satisfy the V_{IL} and V_{IH} specifications and, at the same time, to make the signal line cable as short as possible
- 3. We recommend you to install excess current preventive unit (fuses, etc.) to the power circuit (V_{DD}) (recommend value: 0.5 A)
- 4. Pay sufficient attention to avoid occurrence of mutual noise interference with the neighboring devices
- 5. As for EMI, take necessary measures on the equipment side basically
- 6. When fastening the OLED display module, fasten the external plastic housing section
- 7. If power supply to the OLED display module is forcibly shut down by such errors as taking out the main battery while the OLED display panel is in operation, we cannot guarantee the quality of this OLED display module
 - Connection (contact) to any other potential than the above may lead to rupture of the IC

PRECAUTIONS WHEN DISPOSING OF THE OLED DISPLAY MODULES

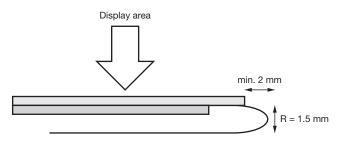
1. Request the qualified companies to handle industrial wastes when disposing of the OLED display modules. Or, when burning them, be sure to observe the environmental and hygienic laws and regulations

OTHER PRECAUTIONS

- 1. When an OLED display module is operated for a long of time with fixed pattern may remain as an after image or slight contrast deviation may occur. Nonetheless, if the operation is interrupted and left unused for a while, normal state can be restored. Also, there will be no problem in the reliability of the module
- 2. To protect OLED display modules from performance drops by static electricity rapture, etc., do not touch the following sections whenever possible while handling the OLED display modules
 - Pins and electrodes
 - Pattern layouts such as the TCP and FPC
- 3. With this OLED display module, the OLED driver is being exposed. Generally speaking, semiconductor elements change their characteristics when light is radiated according to the principle of the solar battery. Consequently, if this OLED driver is exposed to light, malfunctioning may occur
 - Design the product and installation method so that the OLED driver may be shielded from light in actual usage
 - Design the product and installation method so that the OLED driver may be shielded from light during the inspection processes



- 4. Although this OLED display module stores the operation state data by the commands and the indication data, when excessive external noise, etc. enters into the module, the internal status may be changed. It therefore is necessary to take appropriate measures to suppress noise generation or to protect from influences of noise on the system design
- 5. We recommend you to construct its software to make periodical refreshment of the operation statuses (re-setting of the commands and re-transference of the display data) to cope with catastrophic noise
- 6. Resistors, capacitors, and other passive components will have different appearance and color caused by the different supplier
- 7. Our company will has the right to upgrade and modify the product function
- 8. The limitation of FPC bending





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